TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TCK106AF, TCK107AF, TCK108AF

1.0 A Load Switch IC with Slew Rate Control Driver in Small Package

The TCK106AF, TCK107AF and TCK108AF are load switch ICs for a general power management with slew rate control driver, featuring low switch ON resistance and wide input voltage operation from 1.1 to 5.5 V.

Switch ON resistance is only 63 m Ω typical at V_{IN} = 5.0 V, I_{OUT} = -0.5 A condition and output current is available on 1.0 A. TCK107AF and TCK108AF feature output auto-discharge function.

These devices are available in SMV (2.8 mm x 2.9 mm Typ.) package.

Feature

Low ON resistance :

 R_{ON} = 63 m Ω (Typ.) at V_{IN} = 5.0 V, I_{OUT} = -0.5 A R_{ON} = 71 m Ω (Typ.) at V_{IN} = 3.3 V, I_{OUT} = -0.5 A R_{ON} = 101 m Ω (Typ.) at V_{IN} = 1.8 V, I_{OUT} = -0.5 A R_{ON} = 175 m Ω (Typ.) at V_{IN} = 1.2 V, I_{OUT} = -0.2 A R_{ON} = 223 m Ω (Typ.) at V_{IN} = 1.1 V, I_{OUT} = -0.2 A

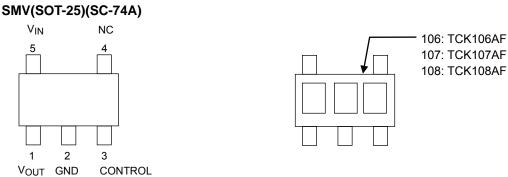
Low Quiescent current

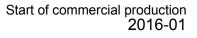
 I_Q = 110 nA (Typ.) at V_{IN} = 5.5 V, I_{OUT} = 0 mA

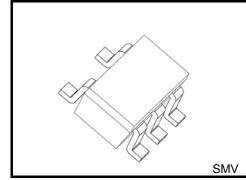
- High output current: I_{OUT} = 1.0 A
- Wide input voltage operation: V_{IN} = 1.1 to 5.5 V
- · Built in Slew rate control driver
- Built in Auto-discharge (TCK107AF and TCK108AF)
- Active High and Pull down connection between CONTROL and GND (TCK106AF and TCK107AF)
- Active Low (TCK108AF)
- General purpose package SMV(SOT-25) (SC-74A)

Pin Assignment (top view)

Top marking







SMV (SOT-25)(SC-74A) : 16 mg (Typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating			Unit	
Input voltage	V _{IN}	-0.3 to 6.0		-0.3 to 6.0		V
Control voltage	V _{CT}	-0.3 to 6.0			V	
Output voltage	Vout	-0.3 to V _{IN} +0.3		(Note1)	V	
Output current	IOUT	DC	1.0		А	
		Pulse	1.5	(Note2)	A	
Power dissipation	PD	200 (Note3)		mW		
		580 (Note4)		IIIVV		
Operating temperature range	T _{opr}	-40 to 85		°C		
Junction temeperature	Tj	150		150		°C
Storage temperature	T _{stg}	-55 to 150		-55 to 150 °		°C

Note : Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

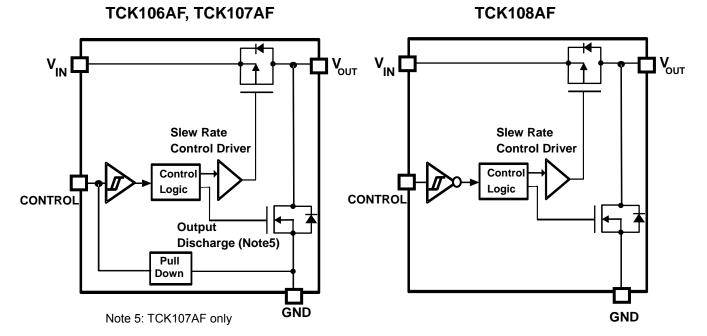
Note 1: V_{IN} +0.3 ≤ 6.0 V

Note 2: 1 ms pulse, 1% duty cycle

Note 3: Unit Rating

Note 4: Rating at mounting on a board (FR4 board: 25.4 mm x 25.4 mm x 1.6 mm)

Block Diagram



Operating conditions

Characteristics	Symbol	Condition	Min	Max	Unit
Input voltage	V _{IN}	—	1.1	5.5	V
Output current	IOUT	—		1.0	А
CONTROL High-level input voltage	VIH	1 1 \/ < \/ < 5 5 \/	0.9	_	V
CONTROL Low-level input voltage	V _{IL}	1.1 V ≤ V _{IN} ≤ 5.5 V	_	0.4	V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Quiescent current (ON state)	ΙQ	V _{IN} = V _{CT} = 5.5 V, I _{OUT} = 0 mA	TCK106AF TCK107AF		110	230	nA
		V _{IN} = 5.5 V, V _{CT} = 0 V, I _{OUT} = 0 mA	TCK108AF				
Standby current (OFF state)	I _{Q(OFF)}		TCK106AF TCK107AF		65	150	nA
		$V_{IN} = V_{CT} = 5.5 V,$ $V_{OUT} = OPEN$ (Note6)	TCK108AF				
OFF-state switch current	ISD(OFF)	V _{IN} = 5.5 V, V _{CT} = 0 V, V _{OUT} = GND	TCK106AF TCK107AF		14	1000	nA
		V _{IN} = V _{CT} = 5.5 V, V _{OUT} = GND	TCK108AF				
On resistance	R _{ON}	V _{IN} = 5.0 V, I _{OUT} = -0.5 A		_	63	90	
		V _{IN} = 3.3 V, I _{OUT} = -0.5 A		-	71	105	mΩ
		V _{IN} = 1.8 V, I _{OUT} = -0.5 A		-	101	155	
		V _{IN} = 1.2 V, I _{OUT} = -0.2 A		_	175	270	
		V _{IN} = 1.1 V, I _{OUT} = -0.2 A		—	223	_	
Discharge on resistance	R _{SD}	— (TCK107AF and TCK1	_	100	—	Ω	

Note 6: Except $I_{\mbox{SD}(\mbox{OFF})}\mbox{OFF-state switch current}$

AC Characteristics (Ta = 25°C)

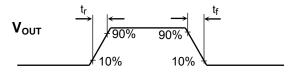
$V_{IN} = 1.2 V$

Characteristics	Symbol	Test Condition (Fig	Min	Тур.	Max	Unit	
V _{OUT} rise time	t _r	R _L = 500 Ω, C _L = 0.1 μ F	_	290	_	μS	
V _{OUT} fall time	t _f	R _L = 500 Ω, C _L = 0.1 μF	TCK107AF TCK108AF	_	30	_	μs
			TCK106AF	_	104	_	
Turn on delay	t _{ON}	R _L = 500 Ω, C _L = 0.1 μ F			305		μS
Turn off delay	toff	R _L = 500 Ω, C _L = 0.1 μ F			5		μS

$V_{IN} = 3.3 V$

Characteristics	Symbol	Test Condition (Figure 1)		Min	Тур.	Max	Unit
V _{OUT} rise time	t _r	R_L = 500 Ω, C_L = 0.1 μF		_	130	_	μS
V _{OUT} fall time	t _f	R _L = 500 Ω, C _L = 0.1 μF	TCK107AF TCK108AF	_	25	_	μs
			TCK106AF	_	110	_	
Turn on delay	t _{ON}	R_L = 500 Ω , C_L = 0.1 μ F			100		μS
Turn off delay	tOFF	R _L = 500 Ω, C _L = 0.1 μ F			10		μS

AC Waveform



TCK106AF, TCK107AF

TCK108AF

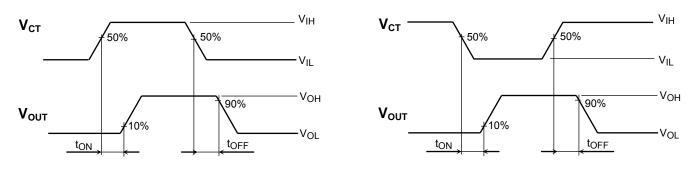
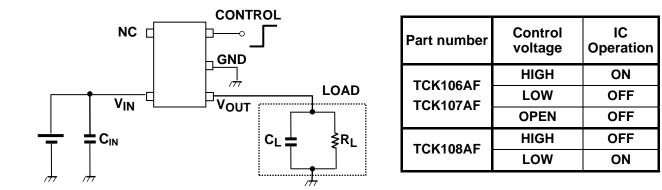


Figure 1 tr, t_{f} , t_{ON} , t_{OFF} Waveforms

Application Note

1. Application circuit example (top view)

The figure below shows the recommended configuration for TCK106AF, TCK107AF and TCK108AF.



1) Input capacitor

An input capacitor (C_{IN}) is not necessary for the guaranteed operation of TCK106AF, TCK107AF and TCK108AF. However, it is recommended to use input capacitors to reduce voltage drop due to sharp changes in output current and also for improved stability of the power supply. When used, place C_{IN} as close to V_{IN} pin to improve stability of the power supply. Also, due to the C_{IN} selected, $V_{IN} < V_{OUT}$ may occur, causing a reverse current to flow through the body diode of the pass-through p-ch MOSFET of the load switch IC. In this case, a higher value for C_{IN} as compared to C_L is recommended.

2) Output capacitor

An output capacitor (C_{OUT}) is not necessary for the guaranteed operation of TCK106AF, TCK107AF and TCK108AF. However, there is a possibility of overshoot or undershoot caused by output load transient response, board layout and parasitic components of load switch IC. In this case, an output capacitor with C_{OUT} more than 0.1µF is recommended.

3) Control pin

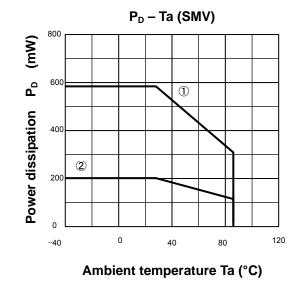
A control pins for TCK106AF and TCK107AF are both Active High and TCK108AF is Active Low. These controls both the pass-through p-ch MOSFET and the discharge n-ch MOSFET (except TCK106AF), operated by the control voltage and Schmitt trigger. When the control voltage level is High (Low; TCK108AF), p-ch MOSFET is ON state and n-ch MOSFET is OFF state. When control voltage level is Low (High; TCK108AF), and the state of the MOSFETs is reversed. Also, pull down resistance equivalent to a few M Ω is connected between CONTROL and GND, thus the load switch IC is in OFF state even when CONTROL pin is OPEN(except TCK108AF). In addition, CONTROL pin has a tolerant function such that it can be used even if the control voltage is higher than the input voltage.

2. Power Dissipation

Both unit and board-mounted power dissipation ratings for TCK106AF, TCK107AF and TCK108AF are available in the Absolute Maximum Ratings table.

Power dissipation is measured on the board shown below.

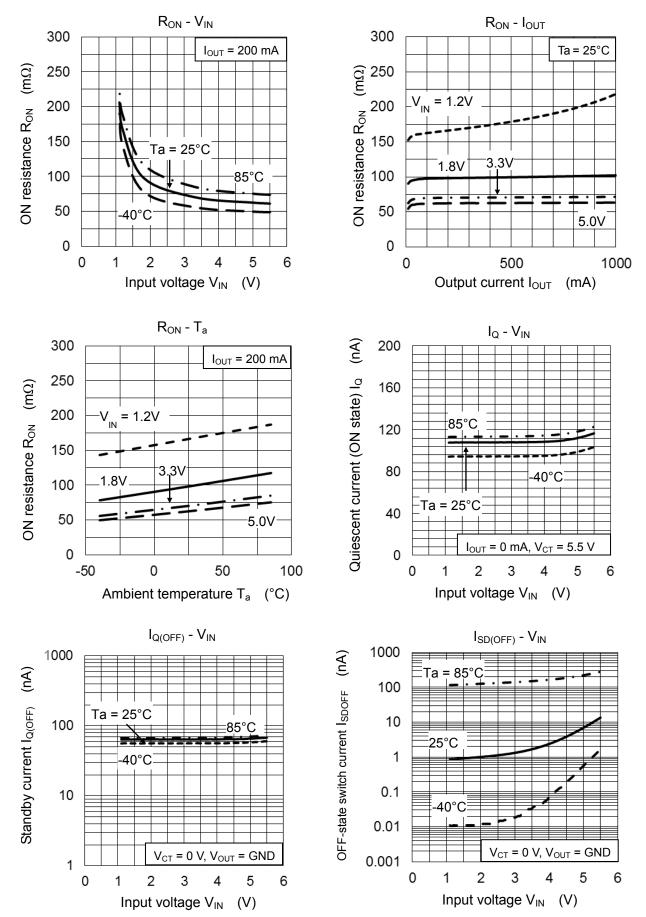
- ①: Rating at mounting on a board Board material: FR4 board Board dimension: 25.4 mm × 25.4 mm × 1.6 mm Copper area: 645 mm²
- 2: Unit Rating



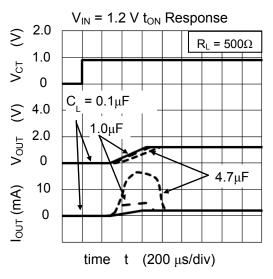
Please allow sufficient margin when designing a board pattern to fit the expected power dissipation. Also take into consideration the ambient temperature, input voltage, output current etc and applying the appropriate derating for allowable power dissipation during operation.

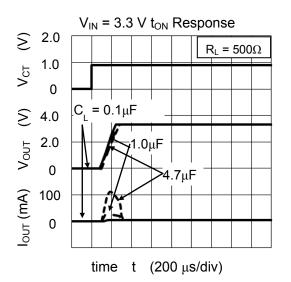
Representative Common Characteristics

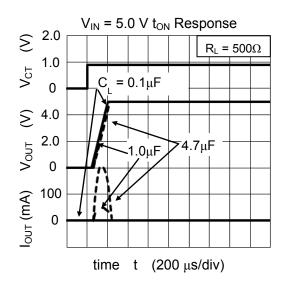
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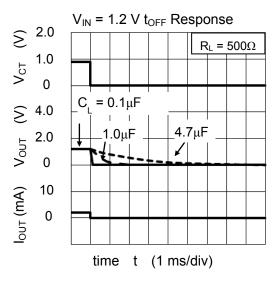
TCK107AF ton Response

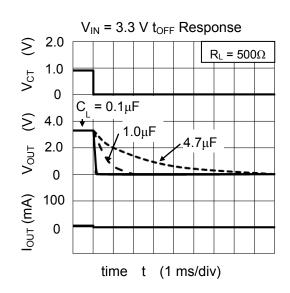


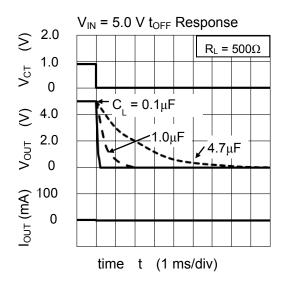




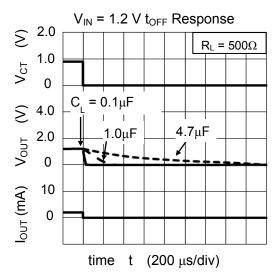
TCK106AF t_{OFF} Response

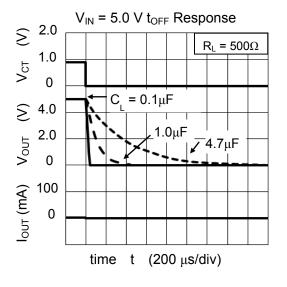


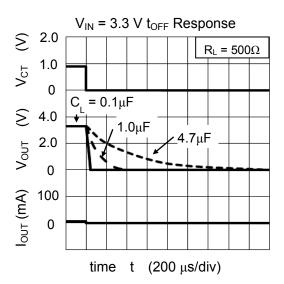




TCK107AF toFF Response



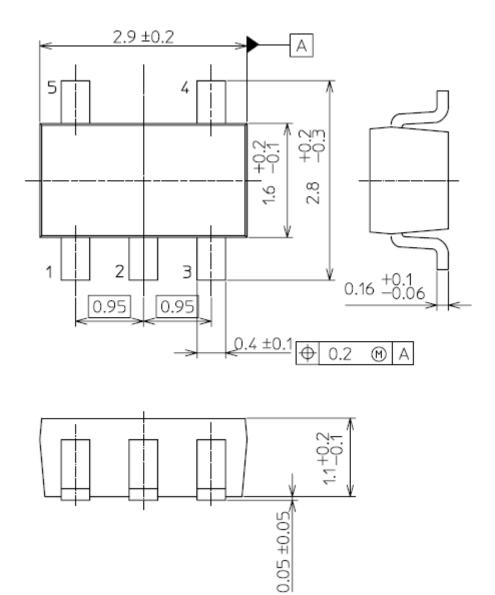




Package dimension

SMV (SOT-25)(SC-74A)

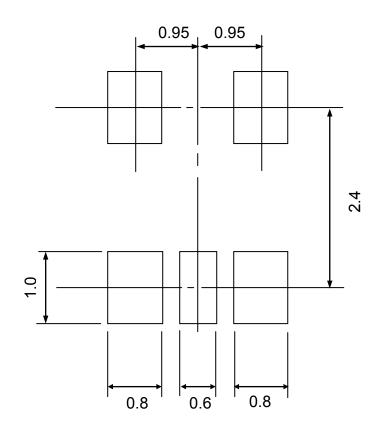
Unit: mm



Weight : 16mg (Typ.)

Land pattern dimensions (for reference only)

Unit: mm



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